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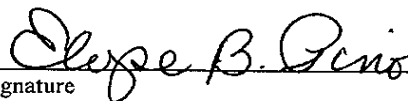
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Hong Yang et al.
Serial No: 09/940,072
Confirmation No: 3068
Filed: August 27, 2001
For: FABRICATION OF CERAMIC MICROSTRUCTURES

Examiner: Christopher A. Fiorilla
Art Unit: 1731

CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)

The undersigned hereby certifies that this document is being placed in the United States mail with first-class postage attached, addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the 12th day of November, 2003.


Signature

Commissioner for Patents
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RESPONSE

Sir:

In response to the Office Action mailed August 12, 2003, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims that begins on page 2 of this amendment.

Remarks begin on page 9 of this amendment.

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